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FDZ375P P-Channel 1.5 V Specified PowerTrench[®] Thin WL-CSP MOSFET -20 V, -3.7 A, 78 m Ω

Features

- Max $r_{DS(on)}$ = 78 m Ω at V_{GS} = -4.5 V, I_D = -2.0 A
- Max $r_{DS(on)}$ = 92 m Ω at V_{GS} = -2.5 V, I_D = -1.5 A
- Max $r_{DS(on)}$ = 112 m Ω at V_{GS} = -1.8 V, I_D = -1.0 A
- Max $r_{DS(on)}$ = 150 m Ω at V_{GS} = -1.5 V, I_D = -1.0 A
- Occupies only 1.0 mm² of PCB area. Less than 30% of the area of 2 x 2 BGA
- Ultra-thin package: less than 0.4 mm height when mounted to PCB
- RoHS Compliant

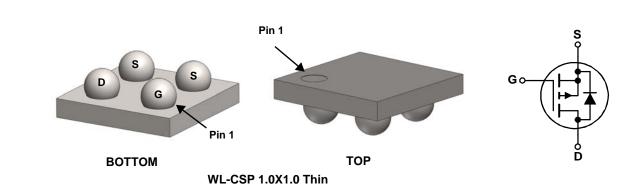


General Description

Designed on Fairchild's advanced 1.5 V PowerTrench[®] process with state of the art "fine pitch" Thin WLCSP packaging process, the FDZ375P minimizes both PCB space and $r_{DS(on)}$. This advanced WLCSP MOSFET embodies a breakthrough in packaging technology which enables the device to combine excellent thermal transfer characteristics, ultra-low profile packaging, low gate charge, and low $r_{DS(on)}$.

Applications

- Battery management
- Load switch
- Battery protection



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			-20	V	
V _{GS}	Gate to Source Voltage			±8	V	
1	-Continuous	T _A = 25°C	(Note 1a)	-3.7		
D	-Pulsed			-12	— A	
P _D	Power Dissipation	T _A = 25°C	(Note 1a)	1.7		
	Power Dissipation	T _A = 25°C	(Note 1b)	0.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	75	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	260	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
Ν	FDZ375P	WL-CSP 1.0X1.0 Thin	7 "	8 mm	5000 units

April 2010

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-0.3	-0.5	-1.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		2		mV/°C
0	Static Drain to Source On Resistance	V_{GS} = -4.5 V, I _D = -2.0 A		65	78	mΩ
r _{DS(on)} Static Drain to Source On Resistance		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -1.5 \text{ A}$		77	92	
		V _{GS} = -1.8 V, I _D = -1.0 A		92	112	
		V _{GS} = -1.5 V, I _D = -1.0 A		112	150	
		V _{GS} = -4.5 V, I _D = -2.0 A, T _{.1} =125°C		98	143	
9 _{FS}	Forward Transconductance	V _{DD} = -5 V, I _D = -3.3 A		11		S
	Characteristics					
C _{iss}	Input Capacitance			650	865	pF
C _{oss}	Output Capacitance	── V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		110	145	pF
C _{rss}	Reverse Transfer Capacitance			95	150	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			5.3	11	ns
t _r	Rise Time	V_{DD} = -10 V, I _D = -3.3 A, V _{GS} = -4.5 V, R _{GEN} = 6 Ω		8.2	15	ns
t _{d(off)}	Turn-Off Delay Time			138	221	ns
t _f	Fall Time			84	124	ns
Q _q	Total Gate Charge	V _{GS} = -4.5 V, V _{DD} = -10 V, I _D = -3.3 A		11	15	nC
Q _{gs}	Gate to Source Charge			0.8		nC
Q _{gd}	Gate to Drain "Miller" Charge	- ID3.3 A		3		nC
Drain-Sou	urce Diode Characteristics					
I _S	Maximum Continuous Drain-Source Diode	Forward Current			-1.1	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.3 A$ (Note 2)		-0.7	-1.2	V
t _{rr}	Reverse Recovery Time			68	109	ns
Q _{rr}	Reverse Recovery Charge	— I _F = -3.3 A, di/dt = 100 A/μs		43	69	nC

Notes:

 R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

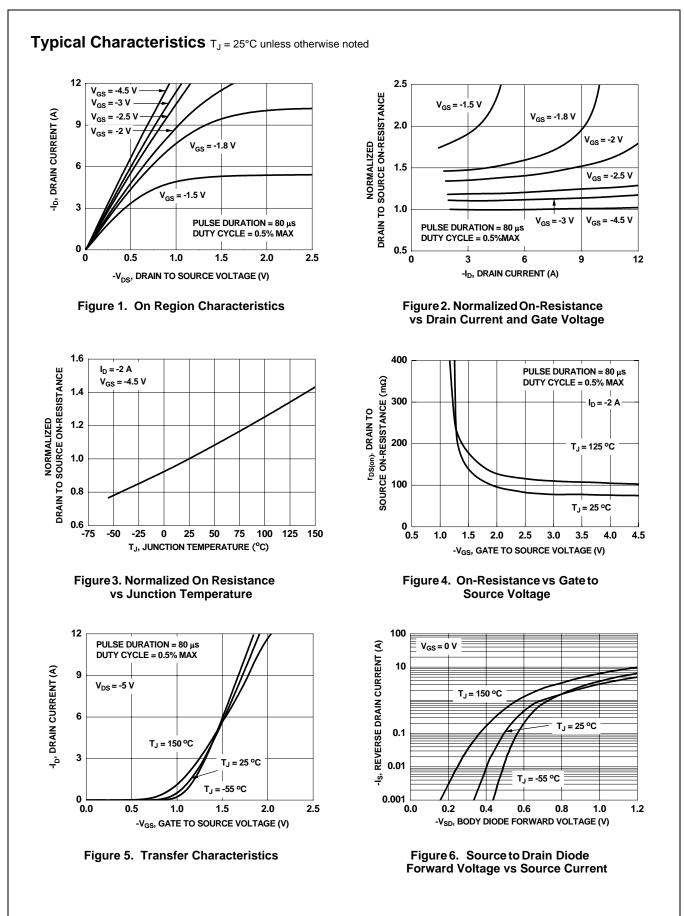


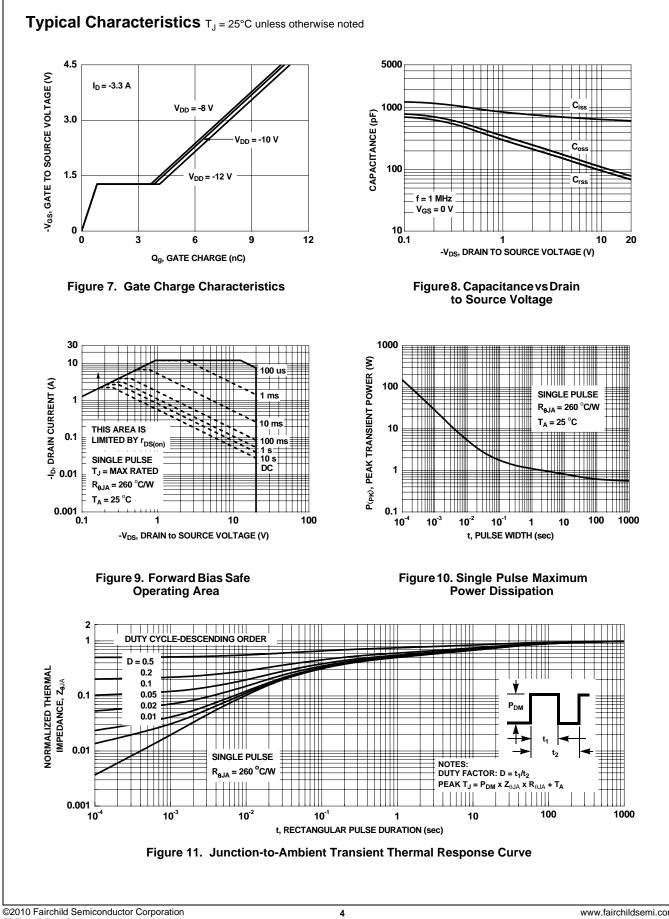
a. 75 °C/W when mounted on a 1 in² pad of 2 oz copper.

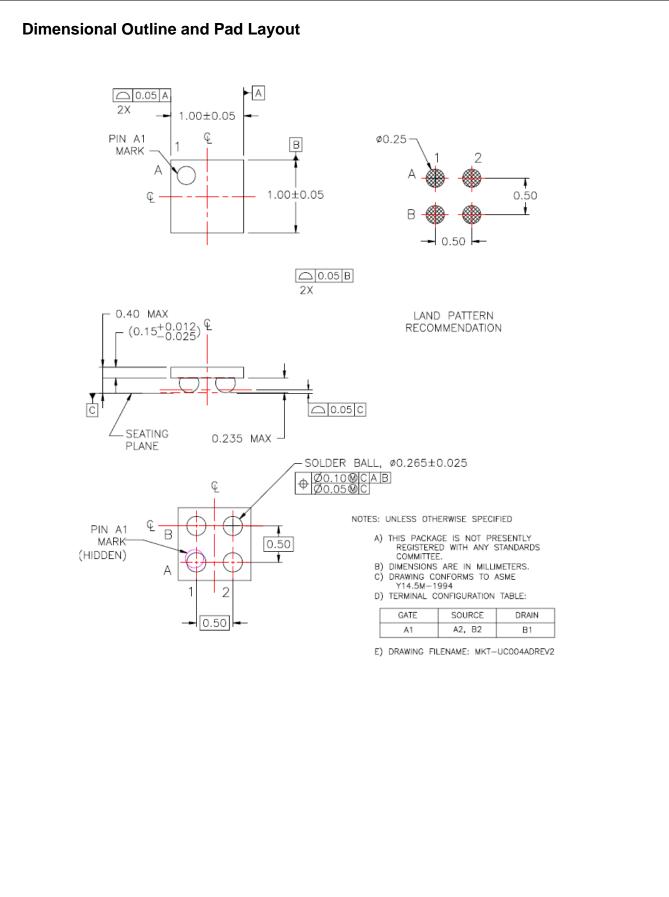
b. 260 °C/W when mounted on a minimum pad of 2 oz copper.

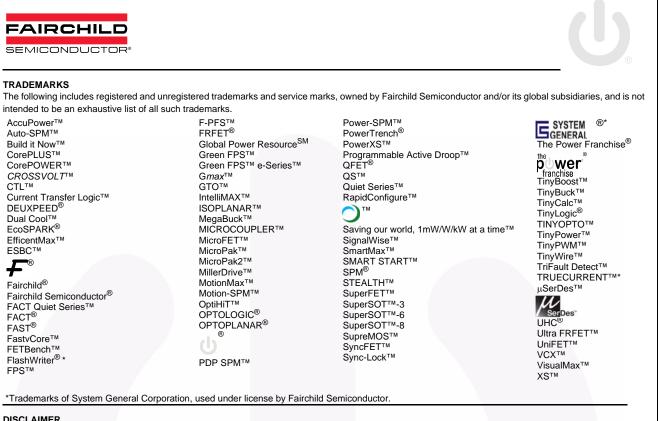
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.











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-	Formative / In Design First Production Full Production

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